

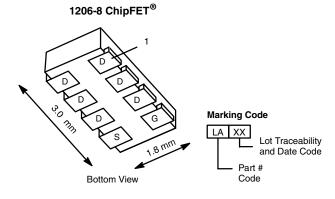
# P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$ $I_{D}\left(A\right)$			
- 20	$0.045$ at $V_{GS} = -4.5 \text{ V}$	- 6.2		
	0.060 at V <sub>GS</sub> = - 2.5 V	- 5.4		
	0.082 at V <sub>GS</sub> = - 1.8 V	- 4.6		

#### **FEATURES**

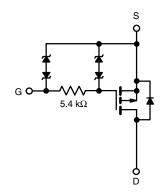
- Halogen-free According to IEC 61249-2-21 Available
- ESD Protected<sup>b</sup> 5000 V





Ordering Information: Si5461EDC-T1-E3 (Lead (Pb)-free)

Si5461EDC-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> T <sub>A</sub> = 25 °C, unless otherwise noted						
Parameter		Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 20		٧	
Gate-Source Voltage		V <sub>GS</sub>	± 12			
Continuous Drain Current /T 150 °C\3	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	- 6.2	- 4.5		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 85 °C		- 4.5	- 3.2		
Pulsed Drain Current		I <sub>DM</sub>	- 20		Α	
Continuous Source Current <sup>a</sup>		I <sub>S</sub>	- 2.1	- 1.1		
Mariana Barra Birata di ad	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5	1.3	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C		1.3	0.7		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) <sup>c, d</sup>			260			

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manianum lumation to Ambienti	t ≤ 5 s	- R <sub>thJA</sub>	40	50	°C/W
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		80	95	
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	15	20	

#### Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. When using HBM. The MM rating is 300 V.
- c. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

# Vishay Siliconix



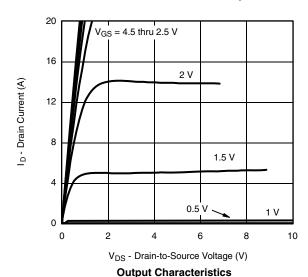
<b>SPECIFICATIONS</b> T <sub>J</sub> = 25 °C, unless otherwise noted							
Parameter	Symbol	Test Conditions Min. T		Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$	- 0.45			V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1.5		
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 16 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
	I <sub>DSS</sub>	V <sub>DS</sub> = - 16 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 85 °C			- 5	1	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5.0 A		0.037	0.045		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 4.0 A		0.050	0.060	Ω	
		V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 2 A		0.066	0.082		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 5.0 A		12		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = - 1.1 A, V <sub>GS</sub> = 0 V		- 0.7	- 1.2	V	
Dynamic <sup>b</sup>							
Total Gate Charge	Qg			12.5	20		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5.0 \text{ A}$		2.0		nC	
Gate-Drain Charge	$Q_{gd}$			4.0			
Turn-On Delay Time	t <sub>d(on)</sub>			2.5	3.5		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 10 $\Omega$		4.5	8.0		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ - 1 A, $V_{GEN}=$ - 4.5 V, $R_G=6~\Omega$		27	40	ns	
Fall Time	t <sub>f</sub>			15	25		

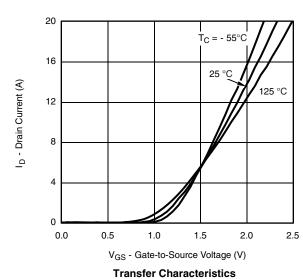
#### Notes:

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



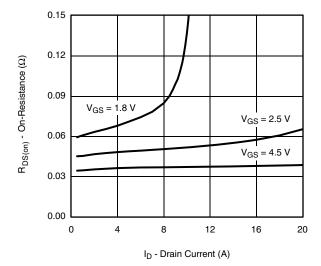




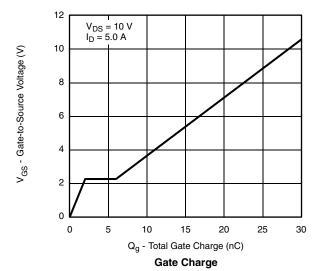


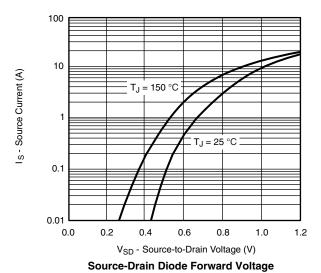


## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### On-Resistance vs. Drain Current

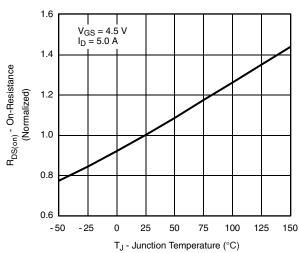




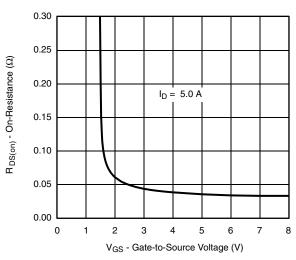
3000 2500 C - Capacitance (pF) Ciss 2000 1500 1000 Coss 500  $\mathsf{C}_{\mathsf{rss}}$ 0 0 8 12 16 20

V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance



On-Resistance vs. Junction Temperature

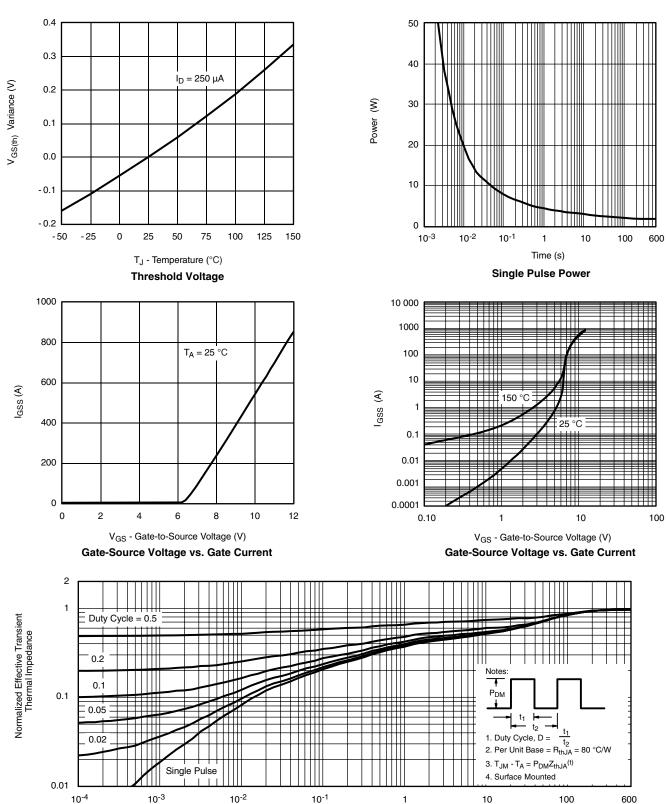


On-Resistance vs. Gate-to-Source Voltage

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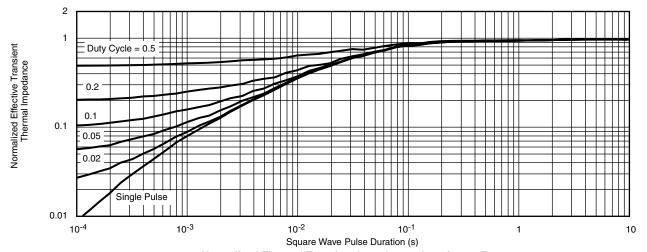
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg271413">www.vishay.com/ppg271413</a>.



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